



Series 0900-CLIP High Reliability Spring Loaded Conntact

preci-dip

	₩	Remplace:		
		Remplacé par:		
	15:1	Dessiné	07.02.2022	C.Bidault
	ו:כו	Contrôlé		
	N° dessin			Révision
	0	907-6-CL	_IP	P2

SOLDERING: Recommanded PCB pad size: 2.0 mm [.078'] Solderability J-STD-002A. Test A 245°C, 5s, solder alloy SnAg3.8Cu0.7 Resistance to soldering heat J-STD-020C, 260°C, 20S

INSULATOR:

If assembling pin into mouliding: Recommanded hole size: Ø1.58[.062']